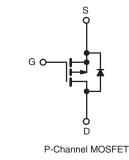
**Vishay Siliconix** 



### **Power MOSFET**

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	- 60					
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = - 10 V	0.50				
Q <sub>g</sub> (Max.) (nC)	12					
Q <sub>gs</sub> (nC)	3.8					
Q <sub>gd</sub> (nC)	5.1					
Configuration	Single					





#### FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- P-Channel
- 175 °C Operating Temperature
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Lead (Pb)-free Available

#### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220 contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION		
Package	TO-220	
Lood (Dh) free	IRF9Z14PbF	
Lead (Pb)-free	SiHF9Z14-E3	
SnPb	IRF9Z14	
	SiHF9Z14	

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	- 60	v	
Gate-Source Voltage			V <sub>GS</sub>	± 20		
Continuous Drain Current	$V_{GS}$ at - 10 V $\frac{T_C}{T_C}$ =	T <sub>C</sub> = 25 °C	I <sub>D</sub>	- 6.7		
	VGS at - TO V	T <sub>C</sub> = 100 °C	ъ	- 4.7	А	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	- 27		
Linear Derating Factor				0.29	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	140	mJ	
Repetitive Avalanche Currenta			I <sub>AR</sub>	- 6.7	Α	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub> 4.3		mJ	
Maximum Power Dissipation	T <sub>C</sub> =	25 °C	PD	P <sub>D</sub> 43		
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	- 4.5	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	°C	
Soldering Recommendations (Peak Temperature)	for	10 s		300 <sup>d</sup>		
Mounting Torque	6.20	C 00 or M0 oprovi		10	lbf ⋅ in	
	6-32 or M3 screw			1.1	N · m	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b.  $V_{DD}$  = - 25 V, starting T<sub>J</sub> = 25 °C, L = 3.6 mH, R<sub>G</sub> = 25  $\Omega$ , I<sub>AS</sub> = - 6.7 A (see fig. 12).

c.  $I_{SD} \leq$  - 6.7 A, dI/dt  $\leq$  90 A/µs,  $V_{DD} \leq V_{DS}, \, T_J \leq$  175 °C.

d. 1.6 mm from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply



Vishay Siliconix



THERMAL RESISTANCE RA	FINGS								
PARAMETER	SYMBOL	TYP. MA		MAX.	L L		UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	- 62 0.50 -							
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>				°C/W				
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	- 3.5				1			
<b>SPECIFICATIONS</b> $T_J = 25 \degree C$ ,	unless otherv	vise noted							
PARAMETER	SYMBOL		CONDITI	IONS	MIN.	TYP.	MAX.	UNIT	
Static					L				
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0$	V, I <sub>D</sub> = - 2	250 μA	- 60	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference	to 25 °C, I	<sub>D</sub> = - 1 mA	-	- 0.060	-	V/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = -250 \mu A$			- 2.0	-	- 4.0	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{GS} = \pm 20 V$			-	-	± 100	nA	
		$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = -48 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 150 \text{ °C}$		-	-	- 100	μA		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>			-	-	- 500			
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 10 V	1		-	-	0.50	Ω	
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = - 2	25 V, I <sub>D</sub> =	- 4.0 A <sup>b</sup>	1.4	-	-	S	
Dynamic									
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = -25 V,$ f = 1.0 MHz, see fig. 5		-	270	-	pF		
Output Capacitance	C <sub>oss</sub>			-	170	-			
Reverse Transfer Capacitance	C <sub>rss</sub>			-	31	-			
Total Gate Charge	Qg				-	-	12		
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = - 10 V		<sub>D</sub> = - 6.7 A, V <sub>DS</sub> = - 48 V, see fig. 6 and 13 <sup>b</sup>	-	-	3.8	nC	
Gate-Drain Charge	Q <sub>gd</sub>		Seel	ig. 6 and 13*	-	-	5.1		
Turn-On Delay Time	t <sub>d(on)</sub>				-	11	-		
Rise Time	t <sub>r</sub>	$V_{DD} = - \ 30 \ V, \ I_D = - \ 6.7 \ A, \\ R_G = 24 \ \Omega, \ R_D = 4.0 \ \Omega, \ see \ fig. \ 10^b$		-	63	-	ns		
Turn-Off Delay Time	t <sub>d(off)</sub>			-	10	-			
Fall Time	t <sub>f</sub>			-	31	-			
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	nH		
Internal Source Inductance	L <sub>S</sub>			-	7.5	-			
Drain-Source Body Diode Characteristic	s				1			1	
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	- 6.7	A		
Pulsed Diode Forward Currenta	I <sub>SM</sub>			-	-	- 27			
Body Diode Voltage	V <sub>SD</sub>	$T_J = 25 \text{ °C}, I_S = -6.7 \text{ A}, V_{GS} = 0 \text{ V}^{b}$			-	-	- 5.5	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = -6.7 \text{ A}, dl/dt = 100 \text{ A}/\mu\text{s}^b$		-	80	160	ns		
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	0.096	0.19	μC		
-		Intrinsic turn-on time is negligible (turn							

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq$  300  $\mu s;$  duty cycle  $\leq$  2 %.



**Vishay Siliconix** 

#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

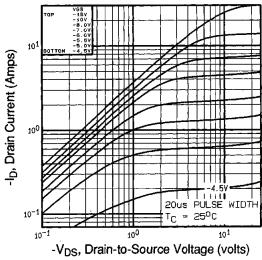
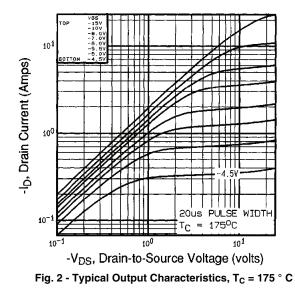


Fig. 1 - Typical Output Characteristics,  $T_C = 25$  °C



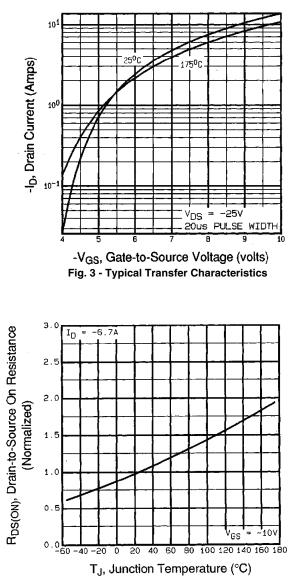
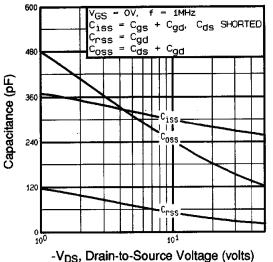
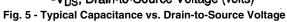


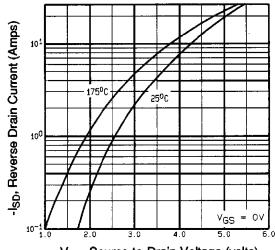
Fig. 4 - Normalized On-Resistance vs. Temperature

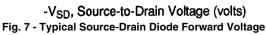
Vishay Siliconix











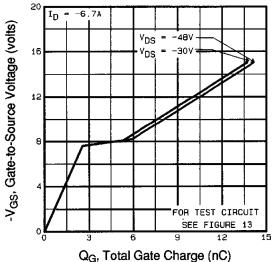
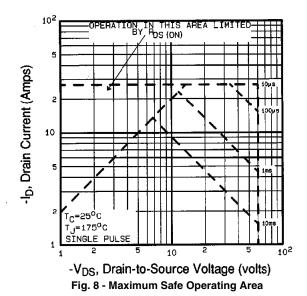


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage





### Vishay Siliconix

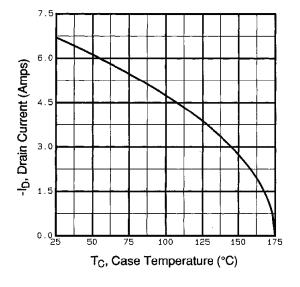


Fig. 9 - Maximum Drain Current vs. Case Temperature

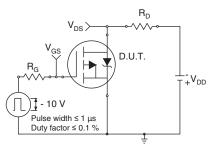


Fig. 10a - Switching Time Test Circuit

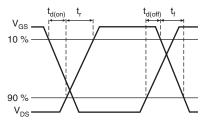
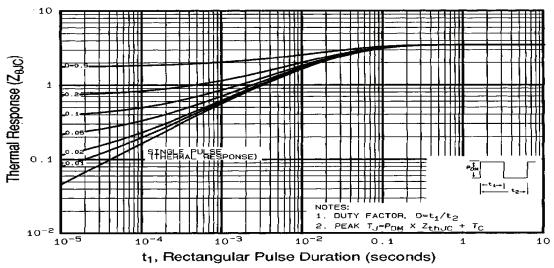
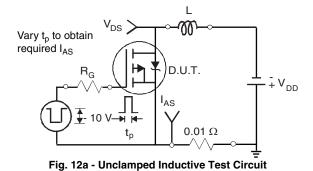
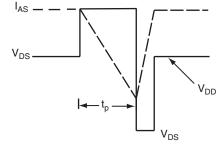


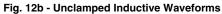
Fig. 10b - Switching Time Waveforms





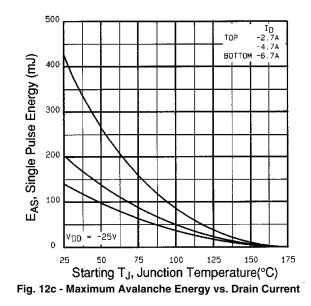


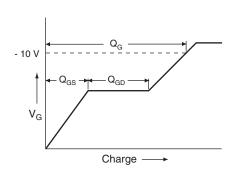


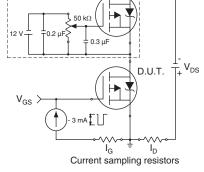


Vishay Siliconix









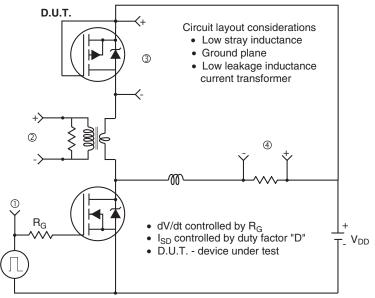
Current regulator Same type as D.U.T

Fig. 13a - Basic Gate Charge Waveform

Fig. 13b - Gate Charge Test Circuit

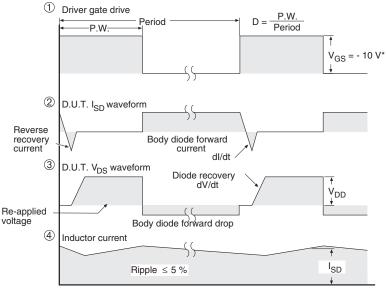


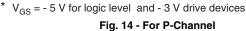
### **Vishay Siliconix**



Peak Diode Recovery dV/dt Test Circuit

• Compliment N-Channel of D.U.T. for driver





Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?91088.



Vishay

# Disclaimer

All product specifications and data are subject to change without notice.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained herein or in any other disclosure relating to any product.

Vishay disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications unless otherwise expressly indicated. Customers using or selling Vishay products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Vishay for any damages arising or resulting from such use or sale. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

Product names and markings noted herein may be trademarks of their respective owners.